









EFFICIENT PRODUCTION SPEED



MODULAR TOP-DOWN BUILD PLATFORM



OPEN PROCESS PARAMETERS MACHINE



## SPECIFICATIONS Number of DLP Heads 1 or 2 heads Investment casting related applications / Technical cera

	Number of DLP Heads	1 or 2 heads
<b>✓</b>	Applications	Investment casting related applications / Technical ceramics / Open for R&D*
	Technology	UV-LED DLP, 385 nm wavelength (365 and 405 nm version on demand)
	Materials	Qualified with Silica and Alumina slurries from Sintx
À	Max. Build envelope size (LxWxH)	300 x 445 x 350 mm 10.3 x 12.9 x 13.7 inches
	Native pixel size (X,Y)	42 μm (0.0016 inches)
	Layer thickness*	50 – 175 μm 0.001 to 0.006 inches
	Platform type	Perforated metal platform
副	Build platform (LxW)	From 75 x 40 mm up to 300 x 445 mm
al	Vat build height	Up to 350 mm - Starts as low as 500 mL initial fill
	Printer size (LxWxH)	855 x 1100 x 1780 mm 33.7 x 43.3 x 70.1 inches
	Weight	510 Kg 1125 lbs.
<b>(4)</b>	Power requirements	210 – 240 VAC, 8-12A, 50/60 Hz

FOR TAILORED SOLUTIONS TO MEET SPECIFIC MATERIAL REQUIREMENTS OR APPLICATIONS, EXPLORE OUR ALTERNATIVE WAVELENGTH OPTION CERAM PRO 405/405+ AND CERAM PRO 365 (including a specific material offer)

<sup>\*</sup> Please note that the application is contingent upon factors including geometry, build style, and material, and variations in these elements may affect outcomes

